

1. Description

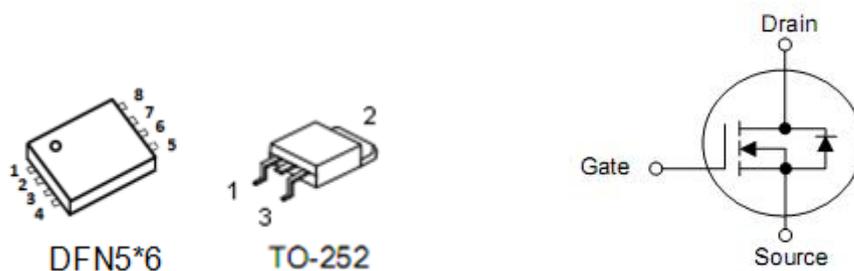
KCX3406A is an N-channel enhancement mode power MOS field effect transistor which is produced using KIA's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance.

This device is widely used in Secondary synchronous rectifier, Power Management for Inverter Systems.

2. Features

- 80A,60V, $R_{DS(ON)(typ.)}=8.5m\Omega @ V_{GS}=10V$
- SGT MOSFET
- Low Gate Charge
- Low Crss
- Fast switching
- Improved dv/dt capability

3. Pin configuration



Pin		Function
DFN5*6	TO-252	
1,2,3	3	Source
4	1	Gate
5,6,7,8	2	Drain

4. Ordering Information

Part Number	Package	Brand
KCY3406A	DFN5*6	KIA
KCD3406A	TO-252	KIA

5. Absolute maximum ratings

$T_A=25^{\circ}\text{C}$ unless otherwise specified

Parameter	Symbol	Ratings	Unit	
Drain-to-Source Voltage	V_{DSS}	60	V	
Gate-to-Source Voltage	V_{GSS}	± 20	V	
Continuous Drain Current	I_D	$T_C=25^{\circ}\text{C}$	80	A
		$T_C=100^{\circ}\text{C}$	48	A
Pulsed Drain Current at $V_{GS}=10\text{V}$	I_{DM}	240	A	
Power Dissipation ($T_C=25^{\circ}\text{C}$)	P_D	63	W	
Derating Factor above 25°C		0.5	W/ $^{\circ}\text{C}$	
Single Pulsed Avalanche Energy ¹⁾	EAS	81	mJ	
Operation Junction Temperature Range	T_J	-55 to 150	$^{\circ}\text{C}$	
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}\text{C}$	

6. Thermal characteristics

Parameter	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.0	$^{\circ}\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	$^{\circ}\text{C/W}$

7. Electrical characteristics

(T_J=25°C, unless otherwise notes)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	60	--	--	V
Drain-to-Source Leakage Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V	--	--	1	uA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	1.0	2.0	3.0	V
Static Drain-to-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =13.5A	--	8.5	9.5	mΩ
		V _{GS} =4.5V, I _D =11.5A	--	13	15	mΩ
Gate Resistance	R _G	F=1MHz	--	1.8	--	Ω
Input Capacitance	C _{iss}	F=1.0MHz, V _{GS} =0V, V _{DS} =30V	--	1065	--	pF
Output Capacitance	C _{oss}		--	430	--	pF
Reverse Transfer Capacitance	C _{rss}		--	22	--	pF
Turn-on Delay Time	t _{d(ON)}	V _{DD} =30V, V _{GS} =10V, R _G =3Ω, I _D =13.5A ^{2), 3)}	--	8	--	nS
Rise Time	t _{rise}		--	54	--	nS
Turn-Off Delay Time	t _{d(OFF)}		--	19	--	nS
Fall Time	t _{fall}		--	8.8	--	nS
Total Gate Charge	Q _g	V _{DD} =48V, V _{GS} =10V, I _D =13.5A ^{2), 3)}	--	16.8	--	nC
Gate-to-Source Charge	Q _{gs}		--	5.9	--	nC
Gate-to-Drain (Miller) Charge	Q _{gd}		--	2.7	--	nC
Continuous Source Current	I _{SD}	Integral Reverse P-N Junction Diode in the MOSFET	--	--	80	A
Pulsed Source Current	I _{SM}		--	--	240	A
Diode Forward Voltage	V _{SD}	I _S =13.5A, V _{GS} =0V	--	--	1.4	V
Reverse Recovery Time	t _{rr}	I _S =13.5A, V _{GS} =0V, dI _F /dt=100A/us ²⁾	--	52	--	ns
Reverse Recovery Charge	Q _{rr}		--	0.05	--	nC

Notes:

1. L=0.5mH, V_{DD}=50V, R_G=10Ω, starting T_J=25°C ;
2. Pulse Test : Pulse width≤300us, Duty cycle≤2% ;
3. Essentially independent of operating temperature.

8. Typical Characteristics

Figure 1. Output Characteristics

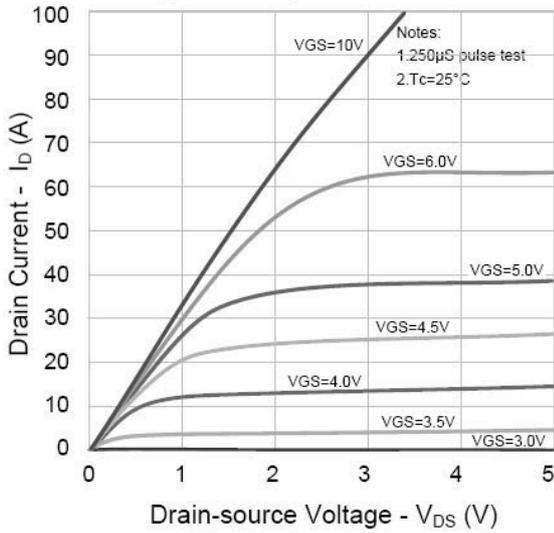


Figure 2. Transfer Characteristics

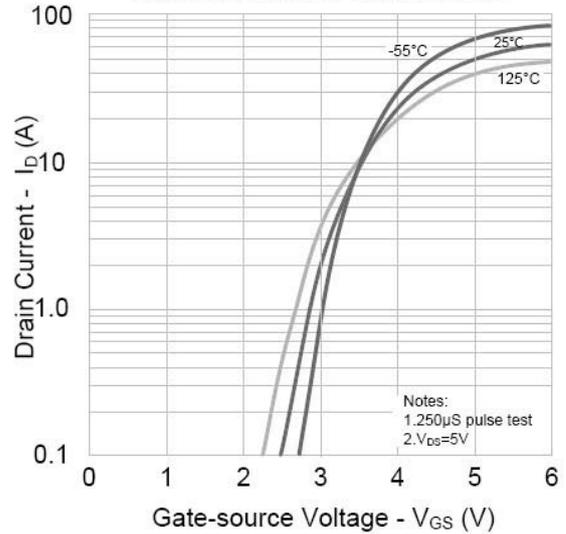


Figure 3. On-resistance vs. Drain Current

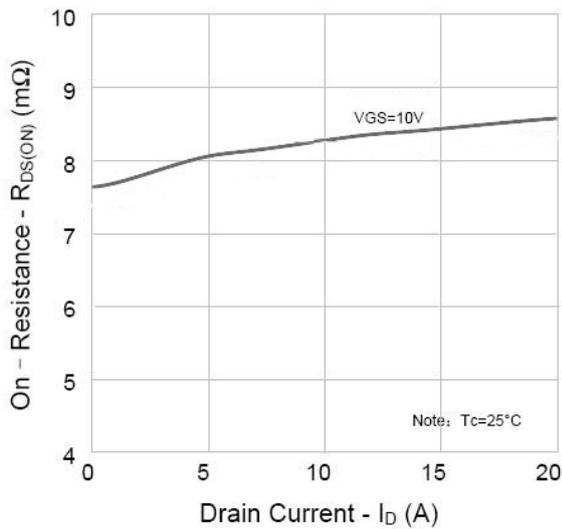


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

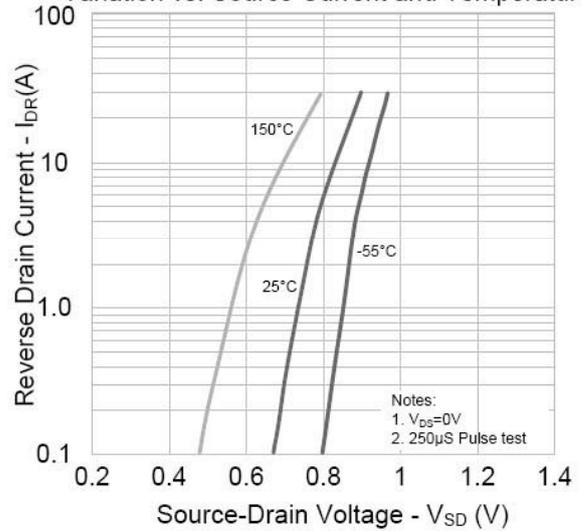


Figure 5. Capacitance Characteristics

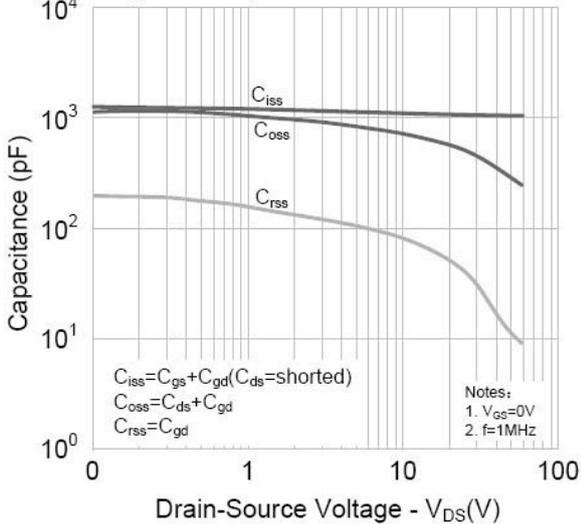


Figure 6. Gate Charge

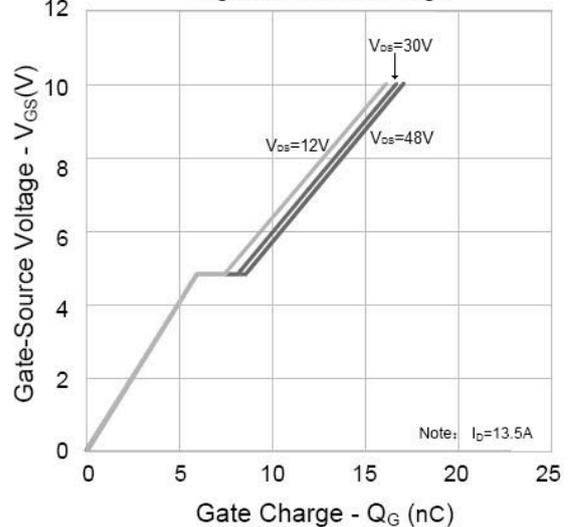


Figure 7. Breakdown Voltage vs. Temperature Characteristics

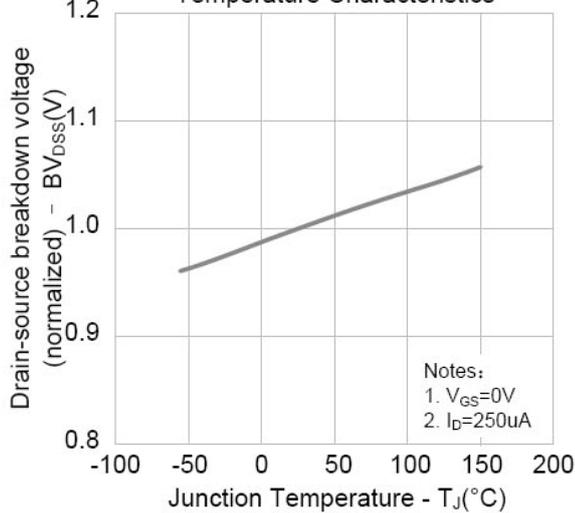


Figure 8. On-resistance vs. Temperature Characteristics

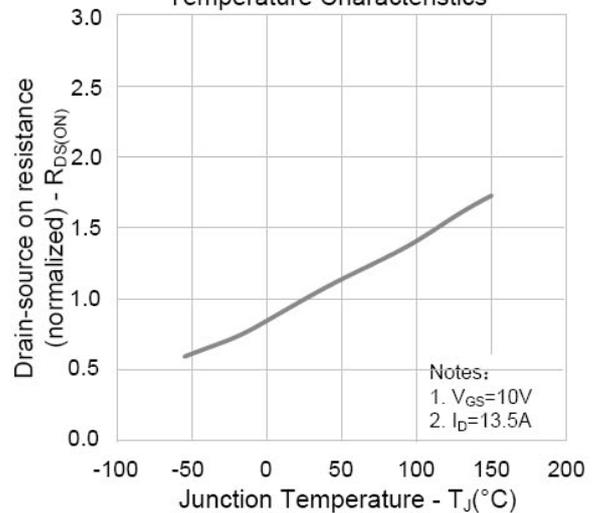


Figure 9-1. Max. Safe Operating Area (SVG069R5ND/MJ)

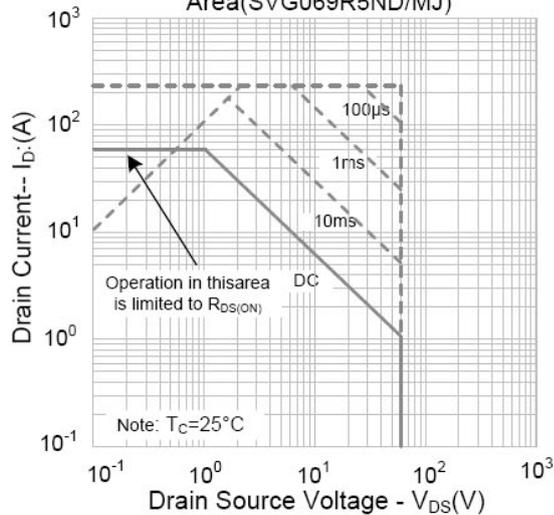
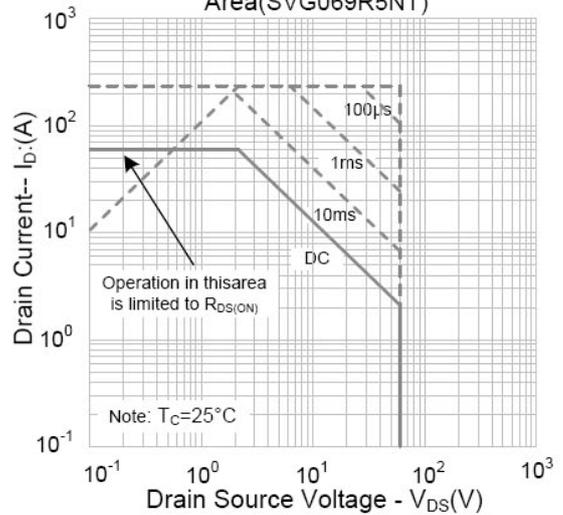
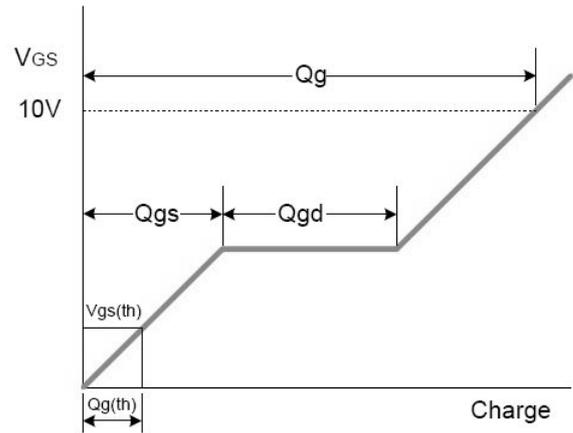
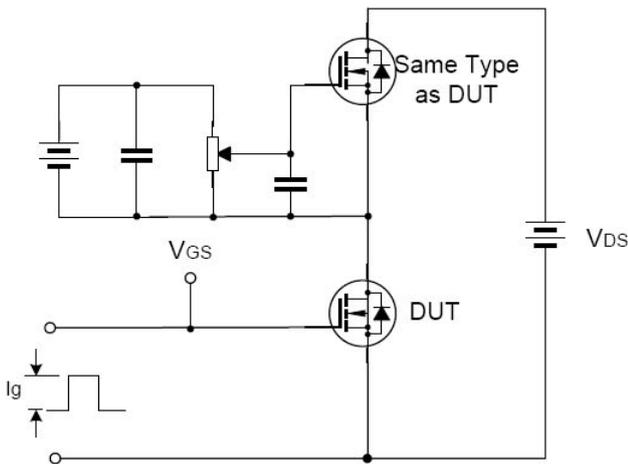


Figure 9-2. Max. Safe Operating Area (SVG069R5NT)

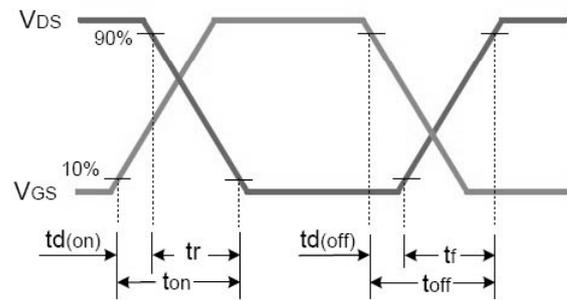
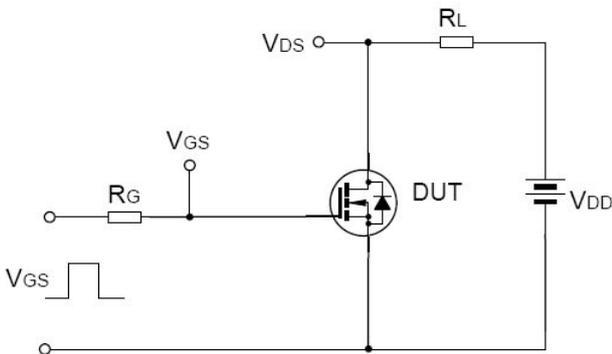


9. Test Circuits and Waveforms

Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

